



PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In the Application of

Ikuya MIYAZAWA

Group Art Unit: 1725

Application No.: 10/090,142

Examiner: L. Edmondson

Filed: March 5, 2002

Docket No.: 112155

For: SOLDERING METHOD, SOLDERING DEVICE, AND METHOD AND DEVICE OF
FABRICATING ELECTRONIC CIRCUIT MODULE

RECEIVED

OCT 29 2003

GROUP 1700

AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In reply to the July 7, 2003 Office Action, please consider the following:

Amendments to the Claims as reflected in the listing of claims; and

Remarks.

10/10/2003 LWONDIM1 00000013 10090142

01 FC:1201

172.00 OP